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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | -   |
| Number of Logic Elements/Cells | 3120  |
| Total RAM Bits                 | 36864   |
| Number of I/O                  | 212   |
| Number of Gates                | 125000  |
| Voltage - Supply               | 1.425V ~ 1.575V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | -40°C ~ 100°C (TJ)  |
| Package / Case                 | 289-TFBGA, CSBGA  |
| Supplier Device Package        | 289-CSP (14x14)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/microchip-technology/aglp125v5-cs289i">https://www.e-xfl.com/product-detail/microchip-technology/aglp125v5-cs289i</a> |

## I/Os Per Package <sup>1</sup>

| IGLOO PLUS Devices | AGLP030           | AGLP060 | AGLP125 |
|--------------------|-------------------|---------|---------|
| Package            | Single-Ended I/Os |         |         |
| CS201              | 120               | 157     | –       |
| CS281              | –                 | –       | 212     |
| CS289              | 120               | 157     | 212     |
| VQ128              | 101               | –       | –       |
| VQ176              | –                 | 137     | –       |

**Note:** When the Flash\*Freeze pin is used to directly enable Flash\*Freeze mode and not used as a regular I/O, the number of single-ended user I/Os available is reduced by one.

**Table 2 • IGLOO PLUS FPGAs Package Size Dimensions**

| Package                         | CS201 | CS281   | CS289   | VQ128   | VQ176   |
|---------------------------------|-------|---------|---------|---------|---------|
| Length × Width (mm/mm)          | 8 × 8 | 10 × 10 | 14 × 14 | 14 × 14 | 20 × 20 |
| Nominal Area (mm <sup>2</sup> ) | 64    | 100     | 196     | 196     | 400     |
| Pitch (mm)                      | 0.5   | 0.5     | 0.8     | 0.4     | 0.4     |
| Height (mm)                     | 0.89  | 1.05    | 1.20    | 1.0     | 1.0     |

## IGLOO PLUS Device Status

| IGLOO PLUS Device | Status     |
|-------------------|------------|
| AGLP030           | Production |
| AGLP060           | Production |
| AGLP125           | Production |

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# 1 – IGLOO PLUS Device Family Overview

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## General Description

The IGLOO PLUS family of flash FPGAs, based on a 130 nm flash process, offers the lowest power FPGA, a single-chip solution, small-footprint packages, reprogrammability, and an abundance of advanced features.

The Flash\*Freeze technology used in IGLOO PLUS devices enables entering and exiting an ultra-low power mode that consumes as little as 5  $\mu$ W while retaining the design information, SRAM content, registers, and I/O states. Flash\*Freeze technology simplifies power management through I/O and clock management with rapid recovery to operation mode.

The Low Power Active capability (static idle) allows for ultra-low power consumption while the IGLOO PLUS device is completely functional in the system. This allows the IGLOO PLUS device to control system power management based on external inputs (e.g., scanning for keyboard stimulus) while consuming minimal power.

Nonvolatile flash technology gives IGLOO PLUS devices the advantage of being a secure, low power, single-chip solution that is Instant On. IGLOO PLUS is reprogrammable and offers time-to-market benefits at an ASIC-level unit cost.

These features enable designers to create high-density systems using existing ASIC or FPGA design flows and tools.

IGLOO PLUS devices offer 1 kbit of on-chip, reprogrammable, nonvolatile FlashROM storage as well as clock conditioning circuitry based on an integrated phase-locked loop (PLL). IGLOO PLUS devices have up to 125 k system gates, supported with up to 36 kbits of true dual-port SRAM and up to 212 user I/Os. The AGLP030 devices have no PLL or RAM support.

## Flash\*Freeze Technology

The IGLOO PLUS device offers unique Flash\*Freeze technology, allowing the device to enter and exit ultra-low power Flash\*Freeze mode. IGLOO PLUS devices do not need additional components to turn off I/Os or clocks while retaining the design information, SRAM content, registers, and I/O states. Flash\*Freeze technology is combined with in-system programmability, which enables users to quickly and easily upgrade and update their designs in the final stages of manufacturing or in the field. The ability of IGLOO PLUS V2 devices to support a wide range of core and I/O voltages (1.2 V to 1.5 V) allows further reduction in power consumption, thus achieving the lowest total system power.

During Flash\*Freeze mode, each I/O can be set to the following configurations: hold previous state, tristate, or set as HIGH or LOW.

The availability of low power modes, combined with reprogrammability, a single-chip and single-voltage solution, and availability of small-footprint, high-pin-count packages, make IGLOO PLUS devices the best fit for portable electronics.

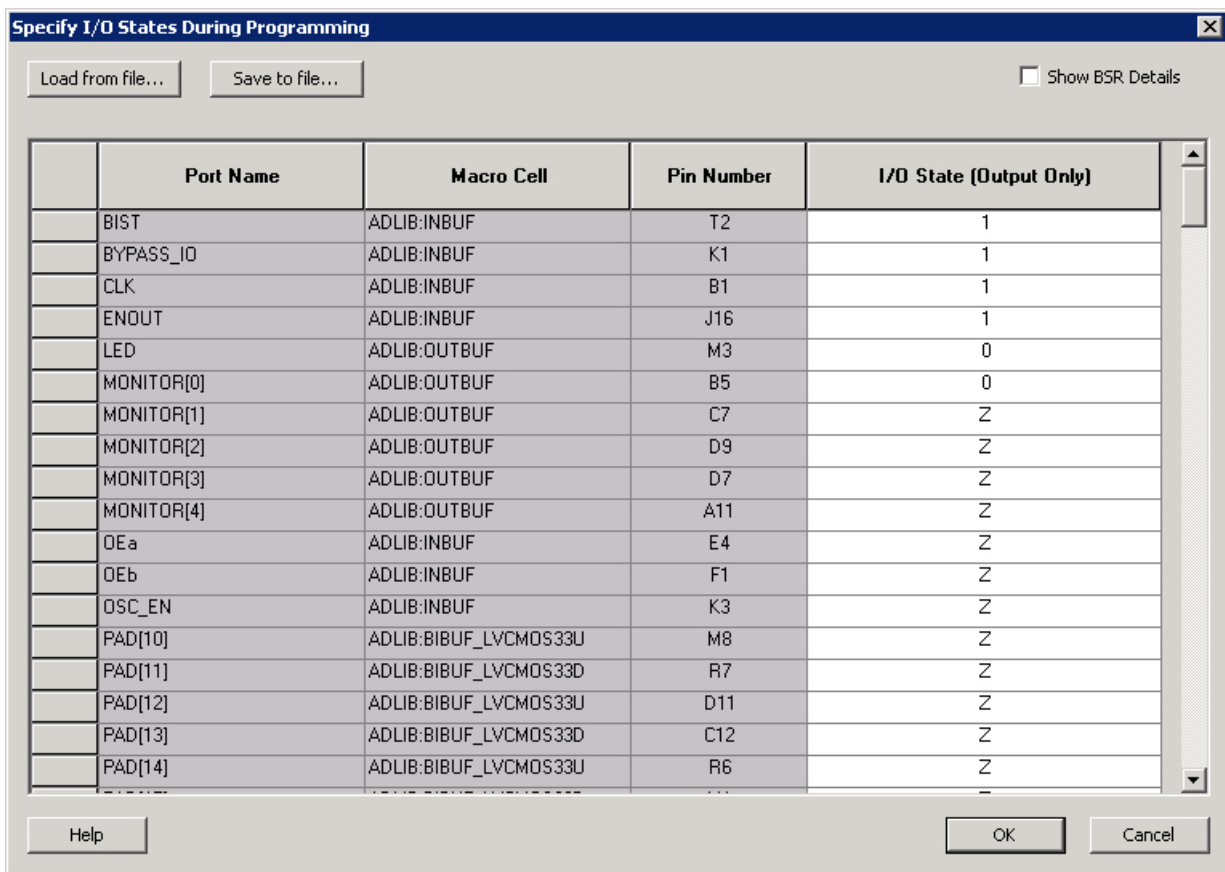
## Flash Advantages

### Low Power

IGLOO PLUS devices exhibit power characteristics similar to those of an ASIC, making them an ideal choice for power-sensitive applications. IGLOO PLUS devices have only a very limited power-on current surge and no high-current transition period, both of which occur on many FPGAs.

IGLOO PLUS devices also have low dynamic power consumption to further maximize power savings; power is even further reduced by the use of a 1.2 V core voltage.

Low dynamic power consumption, combined with low static power consumption and Flash\*Freeze technology, gives the IGLOO PLUS device the lowest total system power offered by any FPGA.



The window titled "Specify I/O States During Programming" contains a table with the following data:

|  | Port Name  | Macro Cell            | Pin Number | I/O State (Output Only) |
|--|------------|-----------------------|------------|-------------------------|
|  | BIST       | ADLIB:INBUF           | T2         | 1                       |
|  | BYPASS_IO  | ADLIB:INBUF           | K1         | 1                       |
|  | CLK        | ADLIB:INBUF           | B1         | 1                       |
|  | ENOUT      | ADLIB:INBUF           | J16        | 1                       |
|  | LED        | ADLIB:OUTBUF          | M3         | 0                       |
|  | MONITOR[0] | ADLIB:OUTBUF          | B5         | 0                       |
|  | MONITOR[1] | ADLIB:OUTBUF          | C7         | Z                       |
|  | MONITOR[2] | ADLIB:OUTBUF          | D9         | Z                       |
|  | MONITOR[3] | ADLIB:OUTBUF          | D7         | Z                       |
|  | MONITOR[4] | ADLIB:OUTBUF          | A11        | Z                       |
|  | OEa        | ADLIB:INBUF           | E4         | Z                       |
|  | OEb        | ADLIB:INBUF           | F1         | Z                       |
|  | OSC_EN     | ADLIB:INBUF           | K3         | Z                       |
|  | PAD[10]    | ADLIB:BIBUF_LVCMOS33U | M8         | Z                       |
|  | PAD[11]    | ADLIB:BIBUF_LVCMOS33D | R7         | Z                       |
|  | PAD[12]    | ADLIB:BIBUF_LVCMOS33U | D11        | Z                       |
|  | PAD[13]    | ADLIB:BIBUF_LVCMOS33D | C12        | Z                       |
|  | PAD[14]    | ADLIB:BIBUF_LVCMOS33U | R6         | Z                       |

Buttons: Load from file..., Save to file..., Show BSR Details (checkbox), Help, OK, Cancel.

**Figure 1-4 • I/O States During Programming Window**

- Click OK to return to the FlashPoint – Programming File Generator window.

**Note:** I/O States During programming are saved to the ADB and resulting programming files after completing programming file generation.

## 2 – IGLOO PLUS DC and Switching Characteristics

### General Specifications

#### Operating Conditions

Stresses beyond those listed in [Table 2-1](#) may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Absolute Maximum Ratings are stress ratings only; functional operation of the device at these or any other conditions beyond those listed under the Recommended Operating Conditions specified in [Table 2-2 on page 2-2](#) is not implied.

**Table 2-1 • Absolute Maximum Ratings**

| Symbol                        | Parameter                    | Limits          | Units |
|-------------------------------|------------------------------|-----------------|-------|
| VCC                           | DC core supply voltage       | –0.3 to 1.65    | V     |
| VJTAG                         | JTAG DC voltage              | –0.3 to 3.75    | V     |
| VPUMP                         | Programming voltage          | –0.3 to 3.75    | V     |
| VCCPLL                        | Analog power supply (PLL)    | –0.3 to 1.65    | V     |
| VCCI                          | DC I/O buffer supply voltage | –0.3 to 3.75    | V     |
| VI <sup>1</sup>               | I/O input voltage            | –0.3 V to 3.6 V | V     |
| T <sub>STG</sub> <sup>2</sup> | Storage temperature          | –65 to +150     | °C    |
| T <sub>J</sub> <sup>2</sup>   | Junction temperature         | +125            | °C    |

**Notes:**

1. The device should be operated within the limits specified by the datasheet. During transitions, the input signal may undershoot or overshoot according to the limits shown in [Table 2-4 on page 2-3](#).
2. For flash programming and retention maximum limits, refer to [Table 2-3 on page 2-3](#), and for recommended operating limits, refer to [Table 2-2 on page 2-2](#).

**Table 2-2 • Recommended Operating Conditions<sup>1,2</sup>**

| Symbol              | Parameter  |  | Commercial     | Industrial     | Units |
|---------------------|--|--|----------------|----------------|-------|
| T <sub>J</sub>      | Junction temperature <sup>2</sup>                  |  | 0 to + 85      | –40 to +100    | °C    |
| VCC <sup>3</sup>    | 1.5 V DC core supply voltage <sup>4</sup>          |  | 1.425 to 1.575 | 1.425 to 1.575 | V     |
|                     | 1.2 V–1.5 V wide range core voltage <sup>5,6</sup> |  | 1.14 to 1.575  | 1.14 to 1.575  | V     |
| VJTAG               | JTAG DC voltage                                    |  | 1.4 to 3.6     | 1.4 to 3.6     | V     |
| VPUMP <sup>7</sup>  | Programming voltage                                | Programming mode                                 | 3.15 to 3.45   | 3.15 to 3.45   | V     |
|                     |  | Operation  | 0 to 3.6       | 0 to 3.6       | V     |
| VCCPLL <sup>8</sup> | Analog power supply (PLL)                          | 1.5 V DC core supply voltage <sup>4</sup>        | 1.425 to 1.575 | 1.425 to 1.575 | V     |
|                     |  | 1.2 V–1.5 V wide range core voltage <sup>5</sup> | 1.14 to 1.575  | 1.14 to 1.575  | V     |
| VCCI                | 1.2 V DC supply voltage <sup>5</sup>               |  | 1.14 to 1.26   | 1.14 to 1.26   | V     |
|                     | 1.2 V DC wide range supply voltage <sup>5</sup>    |  | 1.14 to 1.575  | 1.14 to 1.575  | V     |
|                     | 1.5 V DC supply voltage                            |  | 1.425 to 1.575 | 1.425 to 1.575 | V     |
|                     | 1.8 V DC supply voltage                            |  | 1.7 to 1.9     | 1.7 to 1.9     | V     |
|                     | 2.5 V DC supply voltage                            |  | 2.3 to 2.7     | 2.3 to 2.7     | V     |
|                     | 3.3 V wide range DC supply voltage <sup>9</sup>    |  | 2.7 to 3.6     | 2.7 to 3.6     | V     |
|                     | 3.3 V DC supply voltage                            |  | 3.0 to 3.6     | 3.0 to 3.6     | V     |

**Notes:**

1. All parameters representing voltages are measured with respect to GND unless otherwise specified.
2. To ensure targeted reliability standards are met across ambient and junction operating temperatures, Microsemi recommends that the user follow best design practices using Microsemi's timing and power simulation tools.
3. The ranges given here are for power supplies only. The recommended input voltage ranges specific to each I/O standard are given in [Table 2-21 on page 2-19](#). VCCI should be at the same voltage within a given I/O bank.
4. For IGLOO<sup>®</sup> PLUS V5 devices
5. For IGLOO PLUS V2 devices only, operating at VCCI ≥ VCC.
6. All IGLOO PLUS devices (V5 and V2) must be programmed with the VCC core voltage at 1.5 V. Applications using V2 devices powered by a 1.2 V supply must switch the core supply to 1.5 V for in-system programming.
7. VPUMP can be left floating during operation (not programming mode).
8. VCCPLL pins should be tied to VCC pins. See the Pin Descriptions chapter of the [IGLOO PLUS FPGA Fabric User's Guide](#) for further information.
9. 3.3 V wide range is compliant to the JDEC8b specification and supports 3.0 V VCCI operation.
10. VMV pins must be connected to the corresponding VCCI pins. See the "Pin Descriptions" chapter of the [IGLOO FPGA Fabric User's Guide](#) for further information.
11. Software Default Junction Temperature Range in the Libero SoC software is set to 0°C to +70°C for commercial, and –40°C to +85°C for industrial. To ensure targeted reliability standards are met across the full range of junction temperatures, Microsemi recommends using custom settings for temperature range before running timing and power analysis tools. For more information regarding custom settings, refer to the New Project Dialog Box in the [Libero SoC Online Help](#).

## 2.5 V LVCMOS

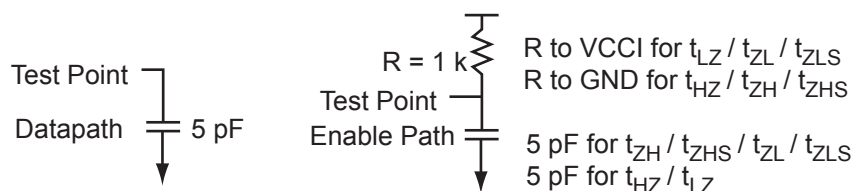
Low-Voltage CMOS for 2.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 2.5 V applications.

**Table 2-46 • Minimum and Maximum DC Input and Output Levels**

| 2.5 V LVCMOS   | VIL    |        | VIH    |        | VOL    | VOH    | IOL | IOH | IOSL                 | IOSH                 | IIL <sup>1</sup> | IIH <sup>2</sup> |
|----------------|--------|--------|--------|--------|--------|--------|-----|-----|----------------------|----------------------|------------------|------------------|
| Drive Strength | Min. V | Max. V | Min. V | Max. V | Max. V | Min. V | mA  | mA  | Max. mA <sup>3</sup> | Max. mA <sup>3</sup> | μA <sup>4</sup>  | μA <sup>4</sup>  |
| 2 mA           | −0.3   | 0.7    | 1.7    | 3.6    | 0.7    | 1.7    | 2   | 2   | 16                   | 18                   | 10               | 10               |
| 4 mA           | −0.3   | 0.7    | 1.7    | 3.6    | 0.7    | 1.7    | 4   | 4   | 16                   | 18                   | 10               | 10               |
| 6 mA           | −0.3   | 0.7    | 1.7    | 3.6    | 0.7    | 1.7    | 6   | 6   | 32                   | 37                   | 10               | 10               |
| 8 mA           | −0.3   | 0.7    | 1.7    | 3.6    | 0.7    | 1.7    | 8   | 8   | 32                   | 37                   | 10               | 10               |
| 12 mA          | −0.3   | 0.7    | 1.7    | 3.6    | 0.7    | 1.7    | 12  | 12  | 65                   | 74                   | 10               | 10               |

**Notes:**

1. IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
2. IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges.
3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.



**Figure 2-8 • AC Loading**

**Table 2-47 • AC Waveforms, Measuring Points, and Capacitive Loads**

| Input Low (V) | Input High (V) | Measuring Point* (V) | C <sub>LOAD</sub> (pF) |
|---------------|----------------|----------------------|------------------------|
| 0             | 2.5            | 1.2                  | 5                      |

**Note:** \*Measuring point = Vtrip. See Table 2-23 on page 2-20 for a complete table of trip points.

## 1.8 V LVCMOS

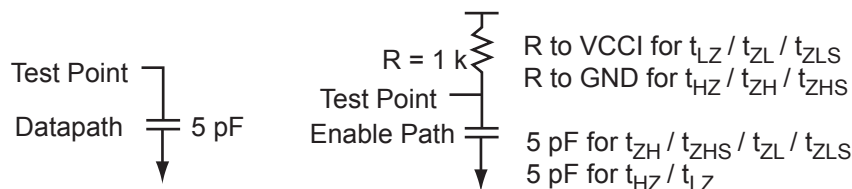
Low-voltage CMOS for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.8 V applications. It uses a 1.8 V input buffer and a push-pull output buffer.

**Table 2-52 • Minimum and Maximum DC Input and Output Levels**

| 1.8 V<br>LVCMOS   | VIL     |             | VIH         |         | VOL     | VOH         | IOL | IOH | IOSL                  | IOSH                  | IIL <sup>1</sup> | IIH <sup>2</sup> |
|-------------------|---------|-------------|-------------|---------|---------|-------------|-----|-----|-----------------------|-----------------------|------------------|------------------|
| Drive<br>Strength | Min., V | Max., V     | Min., V     | Max., V | Max., V | Min., V     | mA  | mA  | Max., mA <sup>3</sup> | Max., mA <sup>3</sup> | μA <sup>4</sup>  | μA <sup>4</sup>  |
| 2 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 2   | 2   | 9                     | 11                    | 10               | 10               |
| 4 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 4   | 4   | 17                    | 22                    | 10               | 10               |
| 6 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 6   | 6   | 35                    | 44                    | 10               | 10               |
| 8 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 8   | 8   | 35                    | 44                    | 10               | 10               |

**Notes:**

1. IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
2. IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges.
3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.



**Figure 2-9 • AC Loading**

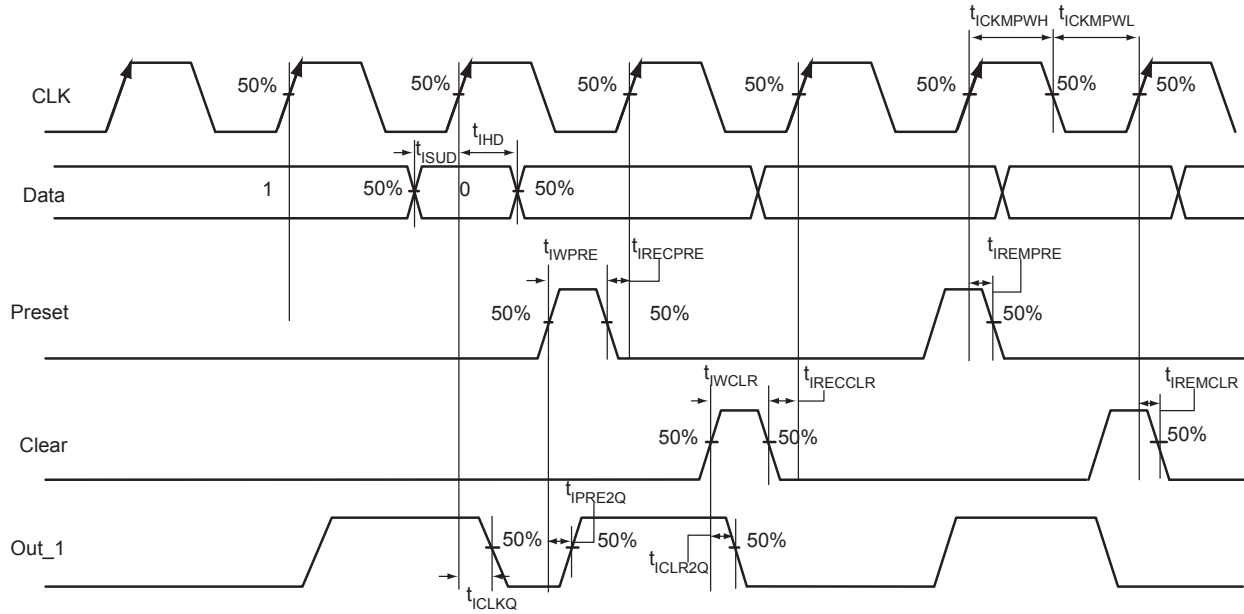
**Table 2-53 • AC Waveforms, Measuring Points, and Capacitive Loads**

| Input Low (V) | Input High (V) | Measuring Point* (V) | C <sub>LOAD</sub> (pF) |
|---------------|----------------|----------------------|------------------------|
| 0             | 1.8            | 0.9                  | 5                      |

**Note:** \*Measuring point = Vtrip. See Table 2-23 on page 2-20 for a complete table of trip points.



## Input Register



**Figure 2-14 • Input Register Timing Diagram**

### Timing Characteristics

1.5 V DC Core Voltage

**Table 2-74 • Input Data Register Propagation Delays**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.425\text{ V}$

| Parameter           | Description   | Std. | Units |
|---------------------|---|------|-------|
| $t_{\text{CLKQ}}$   | Clock-to-Q of the Input Data Register                               | 0.41 | ns    |
| $t_{\text{SUD}}$    | Data Setup Time for the Input Data Register                         | 0.32 | ns    |
| $t_{\text{IHD}}$    | Data Hold Time for the Input Data Register                          | 0.00 | ns    |
| $t_{\text{CLR2Q}}$  | Asynchronous Clear-to-Q of the Input Data Register                  | 0.57 | ns    |
| $t_{\text{PRE2Q}}$  | Asynchronous Preset-to-Q of the Input Data Register                 | 0.57 | ns    |
| $t_{\text{REMCLR}}$ | Asynchronous Clear Removal Time for the Input Data Register         | 0.00 | ns    |
| $t_{\text{RECCLR}}$ | Asynchronous Clear Recovery Time for the Input Data Register        | 0.24 | ns    |
| $t_{\text{REMPRE}}$ | Asynchronous Preset Removal Time for the Input Data Register        | 0.00 | ns    |
| $t_{\text{RECPRE}}$ | Asynchronous Preset Recovery Time for the Input Data Register       | 0.24 | ns    |
| $t_{\text{WCLR}}$   | Asynchronous Clear Minimum Pulse Width for the Input Data Register  | 0.19 | ns    |
| $t_{\text{WPRE}}$   | Asynchronous Preset Minimum Pulse Width for the Input Data Register | 0.19 | ns    |
| $t_{\text{CKMPWH}}$ | Clock Minimum Pulse Width High for the Input Data Register          | 0.31 | ns    |
| $t_{\text{CKMPWL}}$ | Clock Minimum Pulse Width Low for the Input Data Register           | 0.28 | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**Table 2-86 • AGLP125 Global Resource**  
Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ ,  $V_{CC} = 1.425\text{ V}$

| Parameter     | Description                               | Std.              |                   | Units |
|---------------|---|-------------------|-------------------|-------|
|               |   | Min. <sup>1</sup> | Max. <sup>2</sup> |       |
| $t_{RCKL}$    | Input Low Delay for Global Clock          | 1.36              | 1.71              | ns    |
| $t_{RCKH}$    | Input High Delay for Global Clock         | 1.39              | 1.82              | ns    |
| $t_{RCKMPWH}$ | Minimum Pulse Width High for Global Clock | 1.18              |                   | ns    |
| $t_{RCKMPWL}$ | Minimum Pulse Width Low for Global Clock  | 1.15              |                   | ns    |
| $t_{RCKSW}$   | Maximum Skew for Global Clock             |                   | 0.43              | ns    |

**Notes:**

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).
2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).
3. For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**1.2 V DC Core Voltage**

**Table 2-87 • AGLP030 Global Resource**  
Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ ,  $V_{CC} = 1.14\text{ V}$

| Parameter     | Description                               | Std.              |                   | Units |
|---------------|---|-------------------|-------------------|-------|
|               |   | Min. <sup>1</sup> | Max. <sup>2</sup> |       |
| $t_{RCKL}$    | Input Low Delay for Global Clock          | 1.80              | 2.09              | ns    |
| $t_{RCKH}$    | Input High Delay for Global Clock         | 1.88              | 2.27              | ns    |
| $t_{RCKMPWH}$ | Minimum Pulse Width High for Global Clock | 1.40              |                   | ns    |
| $t_{RCKMPWL}$ | Minimum Pulse Width Low for Global Clock  | 1.65              |                   | ns    |
| $t_{RCKSW}$   | Maximum Skew for Global Clock             |                   | 0.39              | ns    |

**Notes:**

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).
2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).
3. For specific junction temperature and voltage supply levels, refer to [Table 2-7 on page 2-6](#) for derating values.

**Table 2-91 • IGLOO PLUS CCC/PLL Specification**  
For IGLOO PLUS V2 Devices, 1.2 V DC Core Supply Voltage

| Parameter   | Min.  | Typ.             | Max.    | Units    |
|---|---|------------------|---------|----------|
| Clock Conditioning Circuitry Input Frequency $f_{IN\_CCC}$        | 1.5   |                  | 160     | MHz      |
| Clock Conditioning Circuitry Output Frequency $f_{OUT\_CCC}$      | 0.75  |                  | 160     | MHz      |
| Delay Increments in Programmable Delay Blocks <sup>1,2</sup>      |   | 580 <sup>3</sup> |         | ps       |
| Number of Programmable Values in Each Programmable Delay Block    |   |                  | 32      |          |
| Serial Clock (SCLK) for Dynamic PLL <sup>4,5</sup>                |   |                  | 60      | MHz      |
| Input Cycle-to-Cycle Jitter (peak magnitude)                      |   |                  | .25     | ns       |
| Acquisition Time  |   |                  |         |          |
| LockControl = 0   |   |                  | 300     | μs       |
| LockControl = 1   |   |                  | 6.0     | ms       |
| Tracking Jitter <sup>6</sup>                                      |   |                  |         |          |
| LockControl = 0   |   |                  | 4       | ns       |
| LockControl = 1   |   |                  | 3       | ns       |
| Output Duty Cycle   | 48.5  |                  | 51.5    | %        |
| Delay Range in Block: Programmable Delay 1 <sup>1,2</sup>         | 2.3   |                  | 20.86   | ns       |
| Delay Range in Block: Programmable Delay 2 <sup>1,2</sup>         | 0.863   |                  | 20.86   | ns       |
| Delay Range in Block: Fixed Delay <sup>1,2</sup>                  |   | 5.7              |         | ns       |
| VCO Output Peak-to-Peak Period Jitter $F_{CCC\_OUT}$ <sup>7</sup> | Maximum Peak-to-Peak Period Jitter <sup>7,8,9</sup> |                  |         |          |
|   | SSO ≤ 2   | SSO ≤ 4          | SSO ≤ 8 | SSO ≤ 16 |
| 0.75 MHz to 50 MHz  | 0.50%   | 1.20%            | 2.00%   | 3.00%    |
| 50 MHz to 160 MHz   | 2.50%   | 5.00%            | 7.00%   | 15.00%   |

**Notes:**

1. This delay is a function of voltage and temperature. See [Table 2-6 on page 2-6](#) and [Table 2-7 on page 2-6](#) for deratings.
2.  $T_J = 25^\circ\text{C}$ ,  $V_{CC} = 1.2\text{ V}$
3. When the CCC/PLL core is generated by Microsemi core generator software, not all delay values of the specified delay increments are available. Refer to the online help associated with the core for more information.
4. Maximum value obtained for a STD speed grade device in Worst Case Commercial Conditions. For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) and [Table 2-7 on page 2-6](#) for derating values.
5. The AGLP030 device does not support PLL.
6. Tracking jitter is defined as the variation in clock edge position of PLL outputs with reference to PLL input clock edge. Tracking jitter does not measure the variation in PLL output period, which is covered by period jitter parameter.
7. VCO output jitter is calculated as a percentage of the VCO frequency. The jitter (in ps) can be calculated by multiplying the VCO period by the per cent jitter. The VCO jitter (in ps) applies to CCC\_OUT regardless of the output divider settings. For example, if the jitter on VCO is 300 ps, the jitter on CCC\_OUT is also 300 ps, regardless of the output divider settings.
8. Measurements are done with LVTTTL 3.3 V, 8 mA, I/O drive strength and high slew rate.  $V_{CC}/V_{CCPLL} = 1.14\text{ V}$ ,  $V_{CCI} = 3.3\text{ V}$ , VQ/PQ/TQ type of packages, 20 pF load.
9. SSO are outputs that are synchronous to a single clock domain, and have their clock-to-out times within  $\pm 200\text{ ps}$  of each other. Switching I/Os are placed outside of the PLL bank. Refer to the "Simultaneously Switching Outputs (SSOs) and Printed Circuit Board Layout" section in the [IGLOO PLUS FPGA Fabric User's Guide](#)

## Embedded SRAM and FIFO Characteristics

### SRAM

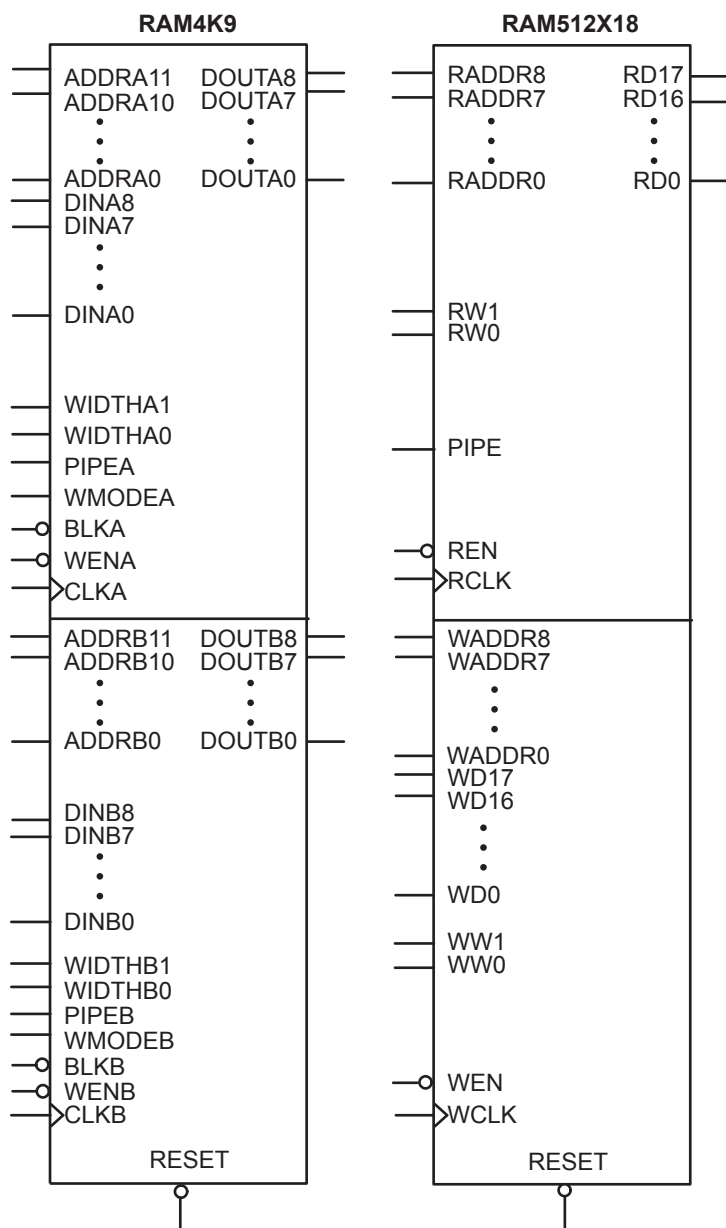
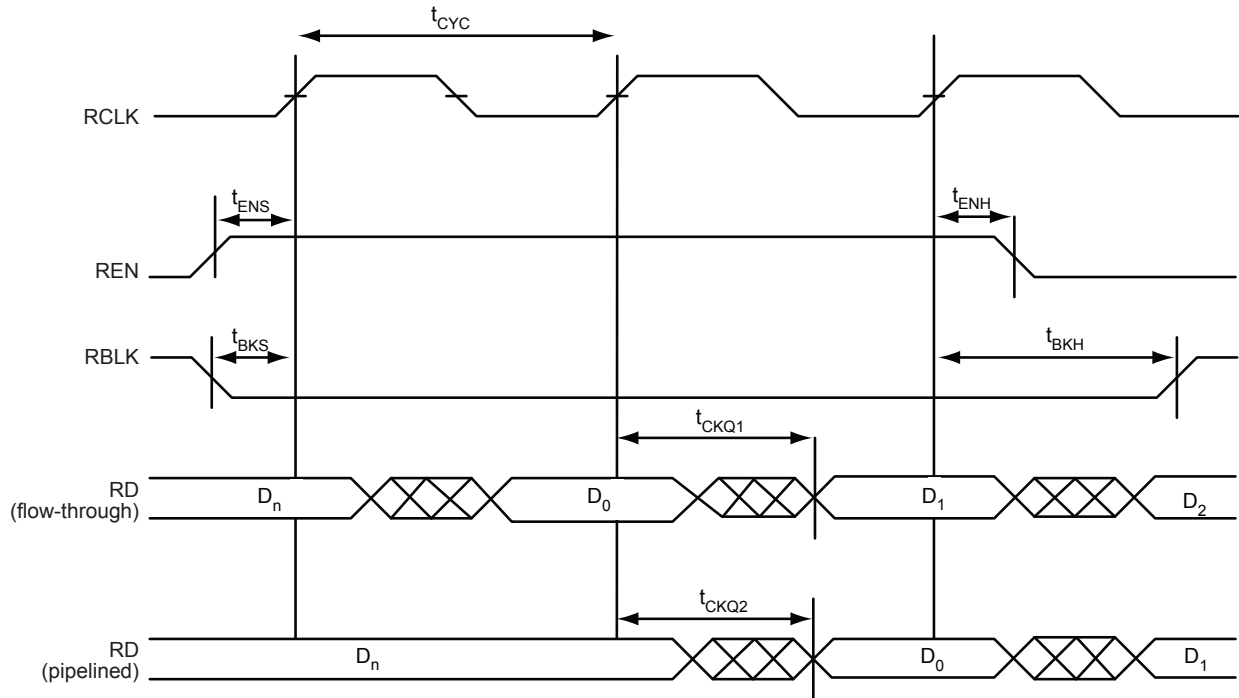
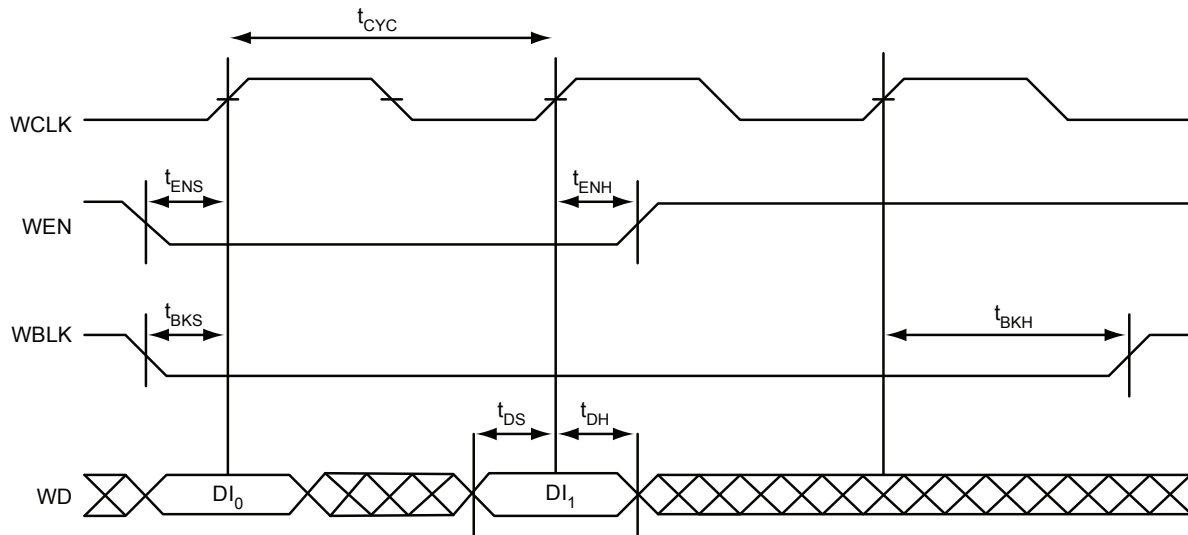


Figure 2-23 • RAM Models

## Timing Waveforms



**Figure 2-30 • FIFO Read**



**Figure 2-31 • FIFO Write**

## JTAG Pins

Low power flash devices have a separate bank for the dedicated JTAG pins. The JTAG pins can be run at any voltage from 1.5 V to 3.3 V (nominal). VCC must also be powered for the JTAG state machine to operate, even if the device is in bypass mode; VJTAG alone is insufficient. Both VJTAG and VCC to the part must be supplied to allow JTAG signals to transition the device. Isolating the JTAG power supply in a separate I/O bank gives greater flexibility in supply selection and simplifies power supply and PCB design. If the JTAG interface is neither used nor planned for use, the VJTAG pin together with the TRST pin could be tied to GND.

### TCK

### Test Clock

Test clock input for JTAG boundary scan, ISP, and UJTAG. The TCK pin does not have an internal pull-up/down resistor. If JTAG is not used, Microsemi recommends tying off TCK to GND through a resistor placed close to the FPGA pin. This prevents JTAG operation in case TMS enters an undesired state.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements. Refer to [Table 3-2](#) for more information.

**Table 3-2 • Recommended Tie-Off Values for the TCK and TRST Pins**

| VJTAG          | Tie-Off Resistance           |
|----------------|------------------------------|
| VJTAG at 3.3 V | 200 $\Omega$ to 1 k $\Omega$ |
| VJTAG at 2.5 V | 200 $\Omega$ to 1 k $\Omega$ |
| VJTAG at 1.8 V | 500 $\Omega$ to 1 k $\Omega$ |
| VJTAG at 1.5 V | 500 $\Omega$ to 1 k $\Omega$ |

#### Notes:

1. Equivalent parallel resistance if more than one device is on the JTAG chain
2. The TCK pin can be pulled up/down.
3. The TRST pin is pulled down.

### TDI

### Test Data Input

Serial input for JTAG boundary scan, ISP, and UJTAG usage. There is an internal weak pull-up resistor on the TDI pin.

### TDO

### Test Data Output

Serial output for JTAG boundary scan, ISP, and UJTAG usage.

### TMS

### Test Mode Select

The TMS pin controls the use of the IEEE 1532 boundary scan pins (TCK, TDI, TDO, TRST). There is an internal weak pull-up resistor on the TMS pin.

### TRST

### Boundary Scan Reset Pin

The TRST pin functions as an active-low input to asynchronously initialize (or reset) the boundary scan circuitry. There is an internal weak pull-up resistor on the TRST pin. If JTAG is not used, an external pull-down resistor could be included to ensure the test access port (TAP) is held in reset mode. The resistor values must be chosen from [Table 3-2](#) and must satisfy the parallel resistance value requirement. The values in [Table 3-2](#) correspond to the resistor recommended when a single device is used, and the equivalent parallel resistor when multiple devices are connected via a JTAG chain.

In critical applications, an upset in the JTAG circuit could allow entrance to an undesired JTAG state. In such cases, Microsemi recommends tying off TRST to GND through a resistor placed close to the FPGA pin.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements.

| CS201      |                  | CS201      |                  | CS201      |                  |
|------------|------------------|------------|------------------|------------|------------------|
| Pin Number | AGLP030 Function | Pin Number | AGLP030 Function | Pin Number | AGLP030 Function |
| A1         | NC               | C6         | IO12RSB0         | F3         | IO119RSB3        |
| A2         | IO04RSB0         | C7         | IO23RSB0         | F4         | IO111RSB3        |
| A3         | IO06RSB0         | C8         | IO19RSB0         | F6         | GND              |
| A4         | IO09RSB0         | C9         | IO28RSB0         | F7         | VCC              |
| A5         | IO11RSB0         | C10        | IO32RSB0         | F8         | VCCIB0           |
| A6         | IO13RSB0         | C11        | IO35RSB0         | F9         | VCCIB0           |
| A7         | IO17RSB0         | C12        | NC               | F10        | VCCIB0           |
| A8         | IO18RSB0         | C13        | GND              | F12        | NC               |
| A9         | IO24RSB0         | C14        | IO41RSB1         | F13        | NC               |
| A10        | IO26RSB0         | C15        | IO37RSB1         | F14        | IO40RSB1         |
| A11        | IO27RSB0         | D1         | IO117RSB3        | F15        | IO38RSB1         |
| A12        | IO31RSB0         | D2         | IO118RSB3        | G1         | NC               |
| A13        | NC               | D3         | NC               | G2         | IO112RSB3        |
| A14        | NC               | D4         | GND              | G3         | IO110RSB3        |
| A15        | NC               | D5         | IO01RSB0         | G4         | IO109RSB3        |
| B1         | NC               | D6         | IO03RSB0         | G6         | VCCIB3           |
| B2         | NC               | D7         | IO10RSB0         | G7         | GND              |
| B3         | IO08RSB0         | D8         | IO21RSB0         | G8         | VCC              |
| B4         | IO05RSB0         | D9         | IO25RSB0         | G9         | GND              |
| B5         | IO07RSB0         | D10        | IO30RSB0         | G10        | GND              |
| B6         | IO15RSB0         | D11        | IO33RSB0         | G12        | NC               |
| B7         | IO14RSB0         | D12        | GND              | G13        | NC               |
| B8         | IO16RSB0         | D13        | NC               | G14        | IO42RSB1         |
| B9         | IO20RSB0         | D14        | IO36RSB1         | G15        | IO44RSB1         |
| B10        | IO22RSB0         | D15        | IO39RSB1         | H1         | NC               |
| B11        | IO34RSB0         | E1         | IO115RSB3        | H2         | GEB0/IO106RSB3   |
| B12        | IO29RSB0         | E2         | IO114RSB3        | H3         | GEC0/IO108RSB3   |
| B13        | NC               | E3         | NC               | H4         | NC               |
| B14        | NC               | E4         | NC               | H6         | VCCIB3           |
| B15        | NC               | E12        | NC               | H7         | GND              |
| C1         | NC               | E13        | NC               | H8         | VCC              |
| C2         | NC               | E14        | GDC0/IO46RSB1    | H9         | GND              |
| C3         | GND              | E15        | GDB0/IO48RSB1    | H10        | VCCIB1           |
| C4         | IO00RSB0         | F1         | IO113RSB3        | H12        | IO54RSB1         |
| C5         | IO02RSB0         | F2         | IO116RSB3        | H13        | GDA0/IO47RSB1    |

| CS281      |                  |
|------------|------------------|
| Pin Number | AGLP125 Function |
| H8         | VCC              |
| H9         | VCCIB0           |
| H10        | VCC              |
| H11        | VCCIB0           |
| H12        | VCC              |
| H13        | VCCIB1           |
| H15        | IO77RSB1         |
| H16        | GCB0/IO82RSB1    |
| H18        | GCA1/IO83RSB1    |
| H19        | GCA2/IO85RSB1    |
| J1         | VCOMPLF          |
| J2         | GFA0/IO189RSB3   |
| J4         | VCCPLF           |
| J5         | GFC0/IO193RSB3   |
| J7         | GFA2/IO188RSB3   |
| J8         | VCCIB3           |
| J9         | GND              |
| J10        | GND              |
| J11        | GND              |
| J12        | VCCIB1           |
| J13        | GCC1/IO79RSB1    |
| J15        | GCA0/IO84RSB1    |
| J16        | GCB2/IO86RSB1    |
| J18        | IO76RSB1         |
| J19        | IO78RSB1         |
| K1         | VCCIB3           |
| K2         | GFA1/IO190RSB3   |
| K4         | GND              |
| K5         | IO19RSB0         |
| K7         | IO197RSB3        |
| K8         | VCC              |
| K9         | GND              |
| K10        | GND              |
| K11        | GND              |
| K12        | VCC              |
| K13        | GCC2/IO87RSB1    |

| CS281      |                  |
|------------|------------------|
| Pin Number | AGLP125 Function |
| K15        | IO89RSB1         |
| K16        | GND              |
| K18        | IO88RSB1         |
| K19        | VCCIB1           |
| L1         | GFB2/IO187RSB3   |
| L2         | IO185RSB3        |
| L4         | GFC2/IO186RSB3   |
| L5         | IO184RSB3        |
| L7         | IO199RSB3        |
| L8         | VCCIB3           |
| L9         | GND              |
| L10        | GND              |
| L11        | GND              |
| L12        | VCCIB1           |
| L13        | IO95RSB1         |
| L15        | IO91RSB1         |
| L16        | NC               |
| L18        | IO90RSB1         |
| L19        | NC               |
| M1         | IO180RSB3        |
| M2         | IO179RSB3        |
| M4         | IO181RSB3        |
| M5         | IO183RSB3        |
| M7         | VCCIB3           |
| M8         | VCC              |
| M9         | VCCIB2           |
| M10        | VCC              |
| M11        | VCCIB2           |
| M12        | VCC              |
| M13        | VCCIB1           |
| M15        | IO122RSB2        |
| M16        | IO93RSB1         |
| M18        | IO92RSB1         |
| M19        | NC               |
| N1         | IO178RSB3        |
| N2         | IO175RSB3        |

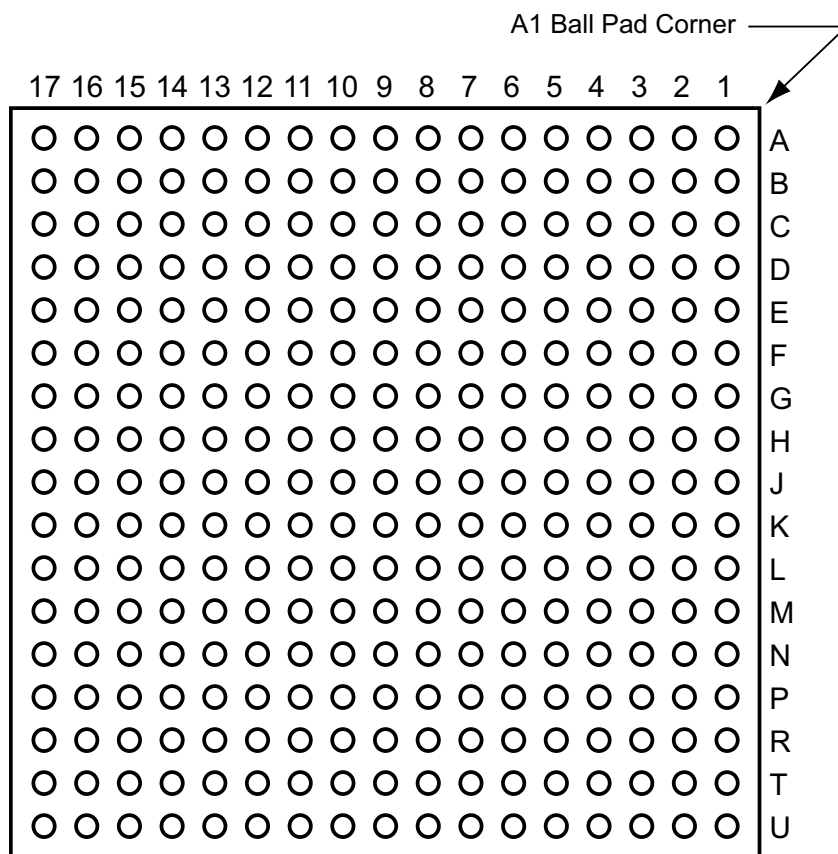
| CS281      |                  |
|------------|------------------|
| Pin Number | AGLP125 Function |
| N4         | IO182RSB3        |
| N5         | IO161RSB2        |
| N7         | GEA2/IO164RSB2   |
| N8         | VCCIB2           |
| N9         | IO137RSB2        |
| N10        | IO135RSB2        |
| N11        | IO131RSB2        |
| N12        | VCCIB2           |
| N13        | VPUMP            |
| N15        | IO117RSB2        |
| N16        | IO96RSB1         |
| N18        | IO98RSB1         |
| N19        | IO94RSB1         |
| P1         | IO174RSB3        |
| P2         | GND              |
| P3         | IO176RSB3        |
| P4         | IO177RSB3        |
| P5         | GEA0/IO165RSB3   |
| P15        | IO111RSB2        |
| P16        | IO108RSB2        |
| P17        | GDC1/IO99RSB1    |
| P18        | GND              |
| P19        | IO97RSB1         |
| R1         | IO173RSB3        |
| R2         | IO172RSB3        |
| R4         | GEC1/IO170RSB3   |
| R5         | GEB1/IO168RSB3   |
| R6         | IO154RSB2        |
| R7         | IO149RSB2        |
| R8         | IO146RSB2        |
| R9         | IO138RSB2        |
| R10        | IO134RSB2        |
| R11        | IO132RSB2        |
| R12        | IO130RSB2        |
| R13        | IO118RSB2        |
| R14        | IO112RSB2        |



| CS281      |                  |
|------------|------------------|
| Pin Number | AGLP125 Function |
| R15        | IO109RSB2        |
| R16        | GDA1/IO103RSB1   |
| R18        | GDB0/IO102RSB1   |
| R19        | GDC0/IO100RSB1   |
| T1         | IO171RSB3        |
| T2         | GEC0/IO169RSB3   |
| T4         | GEB0/IO167RSB3   |
| T5         | IO157RSB2        |
| T6         | IO158RSB2        |
| T7         | IO148RSB2        |
| T8         | IO145RSB2        |
| T9         | IO143RSB2        |
| T10        | GND              |
| T11        | IO129RSB2        |
| T12        | IO126RSB2        |
| T13        | IO125RSB2        |
| T14        | IO116RSB2        |
| T15        | GDC2/IO107RSB2   |
| T16        | TMS              |
| T18        | VJTAG            |
| T19        | GDB1/IO101RSB1   |
| U1         | IO160RSB2        |
| U2         | GEA1/IO166RSB3   |
| U6         | IO151RSB2        |
| U14        | IO121RSB2        |
| U18        | TRST             |
| U19        | GDA0/IO104RSB1   |
| V1         | IO159RSB2        |
| V2         | VCCIB3           |
| V3         | GEC2/IO162RSB2   |
| V4         | IO156RSB2        |
| V5         | IO153RSB2        |
| V6         | GND              |
| V7         | IO144RSB2        |
| V8         | IO141RSB2        |
| V9         | IO140RSB2        |

| CS281      |                       |
|------------|-----------------------|
| Pin Number | AGLP125 Function      |
| V10        | IO133RSB2             |
| V11        | IO127RSB2             |
| V12        | IO123RSB2             |
| V13        | IO120RSB2             |
| V14        | GND                   |
| V15        | IO113RSB2             |
| V16        | GDA2/IO105RSB2        |
| V17        | TDI                   |
| V18        | VCCIB2                |
| V19        | TDO                   |
| W1         | GND                   |
| W2         | FF/GEB2/IO163RSB<br>2 |
| W3         | IO155RSB2             |
| W4         | IO152RSB2             |
| W5         | IO150RSB2             |
| W6         | IO147RSB2             |
| W7         | IO142RSB2             |
| W8         | IO139RSB2             |
| W9         | IO136RSB2             |
| W10        | VCCIB2                |
| W11        | IO128RSB2             |
| W12        | IO124RSB2             |
| W13        | IO119RSB2             |
| W14        | IO115RSB2             |
| W15        | IO114RSB2             |
| W16        | IO110RSB2             |
| W17        | GDB2/IO106RSB2        |
| W18        | TCK                   |
| W19        | GND                   |

## CS289



*Note:* This is the bottom view of the package.

### Note

For Package Manufacturing and Environmental information, visit the Resource Center at <http://www.microsemi.com/soc/products/solutions/package/docs.aspx> .

| CS289      |                  |
|------------|------------------|
| Pin Number | AGLP030 Function |
| A1         | IO03RSB0         |
| A2         | NC               |
| A3         | NC               |
| A4         | GND              |
| A5         | IO10RSB0         |
| A6         | IO14RSB0         |
| A7         | IO16RSB0         |
| A8         | IO18RSB0         |
| A9         | GND              |
| A10        | IO23RSB0         |
| A11        | IO27RSB0         |
| A12        | NC               |
| A13        | NC               |
| A14        | GND              |
| A15        | NC               |
| A16        | NC               |
| A17        | IO30RSB0         |
| B1         | IO01RSB0         |
| B2         | GND              |
| B3         | NC               |
| B4         | NC               |
| B5         | IO07RSB0         |
| B6         | NC               |
| B7         | VCCIB0           |
| B8         | IO17RSB0         |
| B9         | IO19RSB0         |
| B10        | IO24RSB0         |
| B11        | IO28RSB0         |
| B12        | VCCIB0           |
| B13        | NC               |
| B14        | NC               |
| B15        | NC               |
| B16        | IO31RSB0         |
| B17        | GND              |
| C1         | NC               |
| C2         | IO00RSB0         |
| C3         | IO04RSB0         |

| CS289      |                  |
|------------|------------------|
| Pin Number | AGLP030 Function |
| C4         | NC               |
| C5         | VCCIB0           |
| C6         | IO09RSB0         |
| C7         | IO13RSB0         |
| C8         | IO15RSB0         |
| C9         | IO21RSB0         |
| C10        | GND              |
| C11        | IO29RSB0         |
| C12        | NC               |
| C13        | NC               |
| C14        | NC               |
| C15        | GND              |
| C16        | IO34RSB0         |
| C17        | NC               |
| D1         | NC               |
| D2         | IO119RSB3        |
| D3         | GND              |
| D4         | IO02RSB0         |
| D5         | NC               |
| D6         | NC               |
| D7         | NC               |
| D8         | GND              |
| D9         | IO20RSB0         |
| D10        | IO25RSB0         |
| D11        | NC               |
| D12        | NC               |
| D13        | GND              |
| D14        | IO32RSB0         |
| D15        | IO35RSB0         |
| D16        | NC               |
| D17        | NC               |
| E1         | VCCIB3           |
| E2         | IO114RSB3        |
| E3         | IO115RSB3        |
| E4         | IO118RSB3        |
| E5         | IO05RSB0         |
| E6         | NC               |

| CS289      |                  |
|------------|------------------|
| Pin Number | AGLP030 Function |
| E7         | IO06RSB0         |
| E8         | IO11RSB0         |
| E9         | IO22RSB0         |
| E10        | IO26RSB0         |
| E11        | VCCIB0           |
| E12        | NC               |
| E13        | IO33RSB0         |
| E14        | IO36RSB1         |
| E15        | IO38RSB1         |
| E16        | VCCIB1           |
| E17        | NC               |
| F1         | IO111RSB3        |
| F2         | NC               |
| F3         | IO116RSB3        |
| F4         | VCCIB3           |
| F5         | IO117RSB3        |
| F6         | NC               |
| F7         | NC               |
| F8         | IO08RSB0         |
| F9         | IO12RSB0         |
| F10        | NC               |
| F11        | NC               |
| F12        | NC               |
| F13        | NC               |
| F14        | GND              |
| F15        | NC               |
| F16        | IO37RSB1         |
| F17        | IO41RSB1         |
| G1         | IO110RSB3        |
| G2         | GND              |
| G3         | IO113RSB3        |
| G4         | NC               |
| G5         | NC               |
| G6         | NC               |
| G7         | GND              |
| G8         | GND              |
| G9         | VCC              |

| Revision                                | Changes   | Page       |
|---|---|------------|
| Revision 3 (continued)                  | The table note for <a href="#">Table 2-9 • Quiescent Supply Current (IDD) Characteristics, IGLOO PLUS Flash*Freeze Mode*</a> to remove the sentence stating that values do not include I/O static contribution.   | 2-7        |
|   | The table note for <a href="#">Table 2-10 • Quiescent Supply Current (IDD) Characteristics, IGLOO PLUS Sleep Mode*</a> was updated to remove VJTAG and VCCI and the statement that values do not include I/O static contribution.   | 2-7        |
|   | The table note for <a href="#">Table 2-11 • Quiescent Supply Current (IDD) Characteristics, IGLOO PLUS Shutdown Mode</a> was updated to remove the statement that values do not include I/O static contribution.  | 2-7        |
|   | Note 2 of <a href="#">Table 2-12 • Quiescent Supply Current (IDD), No IGLOO PLUS Flash*Freeze Mode 1</a> was updated to include VCCPLL. Table note 4 was deleted.   | 2-8        |
|   | <a href="#">Table 2-13 • Summary of I/O Input Buffer Power (per pin) – Default I/O Software Settings</a> and <a href="#">Table 2-14 • Summary of I/O Output Buffer Power (per pin) – Default I/O Software Settings<sup>1</sup></a> were updated to remove static power. The table notes were updated to reflect that power was measured on VCCI. Table note 2 was added to <a href="#">Table 2-13 • Summary of I/O Input Buffer Power (per pin) – Default I/O Software Settings</a> .   | 2-9, 2-9   |
|   | <a href="#">Table 2-16 • Different Components Contributing to the Static Power Consumption in IGLOO PLUS Devices</a> and <a href="#">Table 2-18 • Different Components Contributing to the Static Power Consumption in IGLOO PLUS Devices</a> were updated to change the definition for P <sub>DC5</sub> from bank static power to bank quiescent power. Table subtitles were added for <a href="#">Table 2-16 • Different Components Contributing to the Static Power Consumption in IGLOO PLUS Devices</a> , <a href="#">Table 2-17 • Different Components Contributing to Dynamic Power Consumption in IGLOO PLUS Devices</a> , and <a href="#">Table 2-18 • Different Components Contributing to the Static Power Consumption in IGLOO PLUS Devices</a> . | 2-10, 2-11 |
|   | The "Total Static Power Consumption—P <sub>STAT</sub> " section was revised.  | 2-12       |
|   | <a href="#">Table 2-32 • Schmitt Trigger Input Hysteresis</a> is new.   | 2-26       |
|   | The "CS281" package drawing is new.   | 4-13       |
| Packaging v1.3                          | The "CS281" table for the AGLP125 device is new.  | 4-13       |
| Revision 3 (continued)                  | The "CS289" package drawing was incorrect. The graphic was showing the CS281 mechanical drawing and not the CS289 mechanical drawing. This has now been corrected.  | 4-17       |
| Revision 2 (Jun 2008)<br>Packaging v1.2 | The "CS289" table for the AGLP030 device is new.  | 4-17       |
| Revision 1 (Jun 2008)<br>Packaging v1.1 | The "CS289" table for the AGLP060 device is new.  | 4-20       |
|   | The "CS289" table for the AGLP125 device is new.  | 4-23       |



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